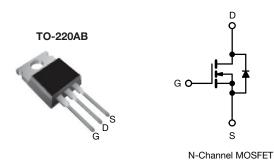


Power MOSFET



| PRODUCT SUMMARY | | | | |
|----------------------------|--------------------------|------|--|--|
| V _{DS} (V) | 100 | | | |
| R _{DS(on)} (Ω) | $V_{GS} = 5.0 \text{ V}$ | 0.27 | | |
| Q _g (Max.) (nC) | 12 | | | |
| Q _{gs} (nC) | 3.0 | | | |
| Q _{gd} (nC) | 7.1 | | | |
| Configuration | Single | | | |

FEATURES

- Dynamic dV/dt rating
- · Repetitive avalanche rated
- · Logic-level gate drive
- R_{DS(on)} specified at V_{GS} = 4 V and 5 V
- 175 °C operating temperature
- · Fast switching
- Ease of paralleling
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

Note

* This datasheet provides information about parts that are RoHS-compliant and / or parts that are non RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details

DESCRIPTION

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost the TO-220AB contribute to its wide acceptance throughout the industry.

| ORDERING INFORMATION | | | |
|---------------------------------|---------------|--|--|
| Package | TO-220AB | | |
| Lead (Pb)-free | IRL520PbF | | |
| Lead (Pb)-free and halogen-free | IRL520PbF-BE3 | | |

| PARAMETER | | | SYMBOL | LIMIT | UNIT | |
|---|------------------------|-------------------------|-----------------------------------|-------------|----------|--|
| Drain-source voltage | | | V _{DS} | 100 | V | |
| Gate-source voltage | | | V_{GS} | ± 10 | v | |
| Continuous drain current | V _{GS} at 5 V | T _C = 25 °C | | 9.2 | | |
| | | T _C = 100 °C | I _D | 6.5 | А | |
| Pulsed drain current ^a | | | I _{DM} | 36 | | |
| Linear derating factor | | | | 0.40 | W/°C | |
| Single pulse avalanche energy b | | | E _{AS} | 170 | mJ | |
| Repetitive avalanche current a | | | I _{AR} | 9.2 | Α | |
| Repetitive avalanche energy ^a | | | E _{AR} | 6.0 | mJ | |
| Maximum power dissipation | T _C = 25 °C | | P_{D} | 60 | W | |
| Peak diode recovery dV/dt c | | | dV/dt | 5.5 | V/ns | |
| Operating junction and storage temperature range | | | T _J , T _{stg} | -55 to +175 | - °C | |
| Soldering recommendations (peak temperature) ^d | For 10 s | | | 300 d | | |
| Mounting torque | 6.00.04 | 0.00 140 | | 10 | lbf ⋅ in | |
| | 6-32 or M3 screw | | | 1.1 | N·m | |

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)
- b. V_{DD} = 25 V, starting T_J = 25 °C, L = 3.0 mH, R_g = 25 Ω , I_{AS} = 9.2 A (see fig. 12)
- c. $I_{SD} \le 9.2 \text{ A}$, $dI/dt \le 110 \text{ A/}\mu\text{s}$, $V_{DD} \le V_{DS}$, $T_J \le 175 \,^{\circ}\text{C}$
- d. 1.6 mm from case



Vishay Siliconix

| THERMAL RESISTANCE RATINGS | | | | | |
|-------------------------------------|-------------------|------|------|------|--|
| PARAMETER | SYMBOL | TYP. | MAX. | UNIT | |
| Maximum junction-to-ambient | R _{thJA} | - | 62 | | |
| Case-to-sink, flat, greased surface | R _{thCS} | 0.50 | - | °C/W | |
| Maximum junction-to-case (drain) | R _{thJC} | - | 2.5 | | |

| PARAMETER | SYMBOL | TES | MIN. | TYP. | MAX. | UNIT | |
|---|-----------------------|--|---|------|------|-------|------------------|
| Static | | | | | | | <u> </u> |
| Drain-source breakdown voltage | V _{DS} | V _{GS} = | 100 | - | - | V | |
| V _{DS} temperature coefficient | $\Delta V_{DS}/T_{J}$ | Reference | Reference to 25 °C, I _D = 1 mA | | 0.12 | - | V/°C |
| Gate-source threshold voltage | V _{GS(th)} | V _{DS} = | $V_{DS} = V_{GS}, I_D = 250 \mu A$ | | - | 2.0 | V |
| Gate-source leakage | I _{GSS} | V _{GS} = ± 10 V | | - | - | ± 100 | nA |
| Zero gate voltage drain current | I _{DSS} | V _{DS} = | V _{DS} = 100 V, V _{GS} = 0 V | | - | 25 | |
| | | V _{DS} = 80 V | V _{GS} = 0 V, T _J = 150 °C | - | - | 250 | μA |
| Drain-source on-state resistance | _ | V _{GS} = 5.0 V | I _D = 5.5 A ^b | - | - | 0.27 | Ω |
| | R _{DS(on)} | V _{GS} = 4.0 V | I _D = 4.6 A ^b | - | - | 0.38 | |
| Forward transconductance | g _{fs} | V _{DS} = 50 V, I _D = 5.5 A | | 3.2 | - | - | S |
| Dynamic | | | | | | | |
| Input capacitance | C _{iss} | $V_{GS} = 0 \text{ V},$ $V_{DS} = 25 \text{ V},$ $f = 1.0 \text{ MHz, see fig. 5}$ | | - | 490 | - | pF |
| Output capacitance | C _{oss} | | | - | 150 | - | |
| Reverse transfer capacitance | C _{rss} | | | - | 30 | - | |
| Total gate charge | Qg | | | - | ı | 12 | nC |
| Gate-source charge | Q_{gs} | $V_{GS} = 5.0 \text{ V}$ | $I_D = 9.2 \text{ A}, V_{DS} = 80 \text{ V},$ see fig. 6 and 13 ^b | - | - | 3.0 | |
| Gate-drain charge | Q_{gd} | | 366 lig. 6 and 16 | | - | 7.1 | 1 |
| Turn-on delay time | t _{d(on)} | | | - | 9.8 | - | |
| Rise time | t _r | $V_{DD} = 50 \text{ V}, I_D = 9.2 \text{ A},$ $R_g = 9.0 \ \Omega, \ R_D = 5.2 \ \Omega, \text{ see fig. } 10^b$ | | - | 64 | - | ns |
| Turn-off delay time | t _{d(off)} | | | - | 21 | - | |
| Fall time | t _f | | | - | 27 | - | |
| Internal drain inductance | L _D | Between lead, 6 mm (0.25") from package and center of die contact | | - | 4.5 | - | nH |
| Internal source inductance | L _S | | | - | 7.5 | - | ''' |
| Drain-Source Body Diode Characteristic | cs | | | | | | |
| Continuous source-drain diode current | I _S | showing the | MOSFET symbol showing the | | - | 9.2 | А |
| Pulsed diode forward current ^a | I _{SM} | integral reverse p - n junction diode | | - | - | 36 | |
| Body diode voltage | V _{SD} | $T_J = 25 ^{\circ}\text{C}, I_S = 9.2 \text{A}, V_{GS} = 0 \text{V}^{\text{b}}$ | | - | - | 2.5 | V |
| Body diode reverse recovery time | t _{rr} | - T _J = 25 °C, I _F = 9.2 A, dl/dt = 100 A/μs ^b | | - | 130 | 190 | ns |
| Body diode reverse recovery charge | Q _{rr} | | | - | 0.83 | 1.0 | μC |
| Forward turn-on time | t _{on} | Intrinsic turn-on time is negligible (turn-on is dominated by L _S and L _D) | | | | | L _D) |

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)
- b. Pulse width \leq 300 µs; duty cycle \leq 2 %



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

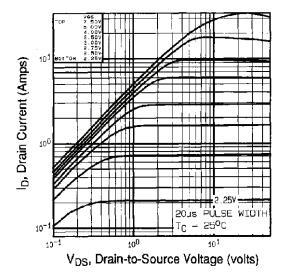


Fig. 1 - Typical Output Characteristics, T_C = 25 °C

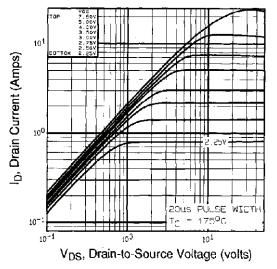


Fig. 2 - Typical Output Characteristics, $T_C = 175$ °C

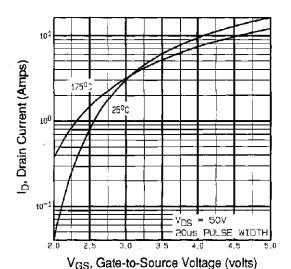


Fig. 3 - Typical Transfer Characteristics

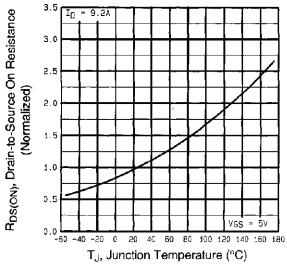


Fig. 4 - Normalized On-Resistance vs. Temperature



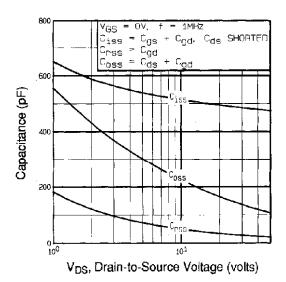


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

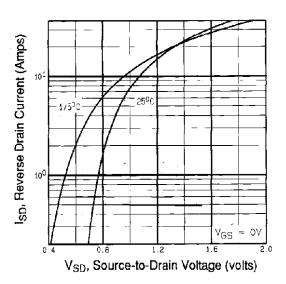


Fig. 7 - Typical Source-Drain Diode Forward Voltage

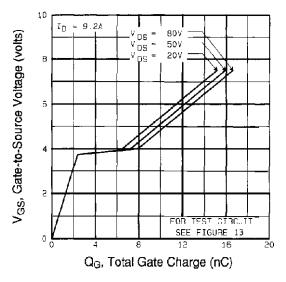


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

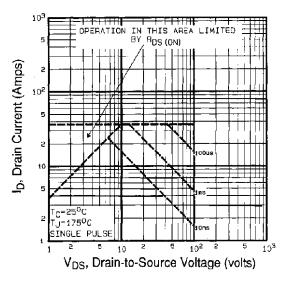


Fig. 8 - Maximum Safe Operating Area



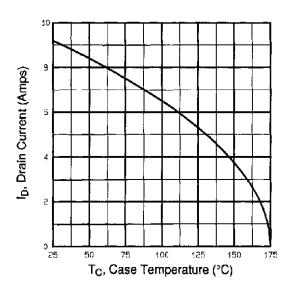


Fig. 9 - Maximum Safe Operating Area

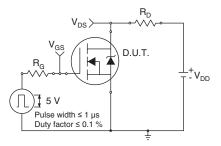


Fig. 10a - Switching Time Test Circuit

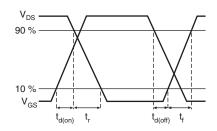


Fig. 10b - Switching Time Waveforms

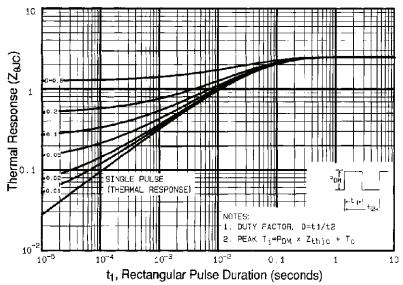
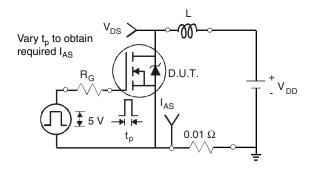


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case







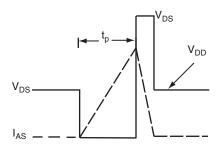


Fig. 12b - Unclamped Inductive Waveforms

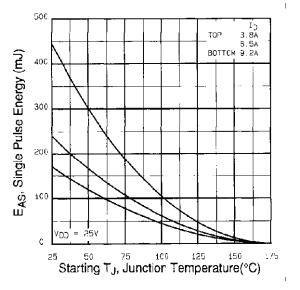


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

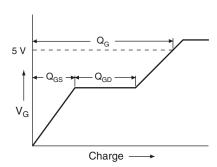


Fig. 13a - Basic Gate Charge Waveform

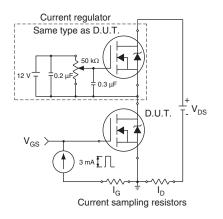
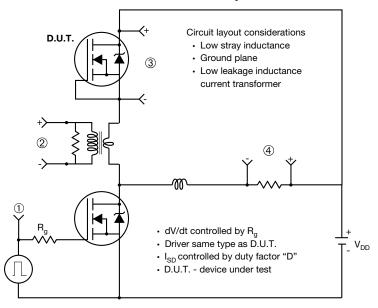


Fig. 13b - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



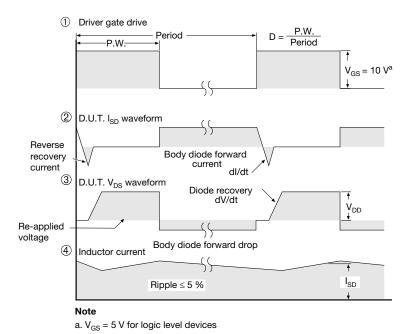


Fig. 14 - For N-Channel

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